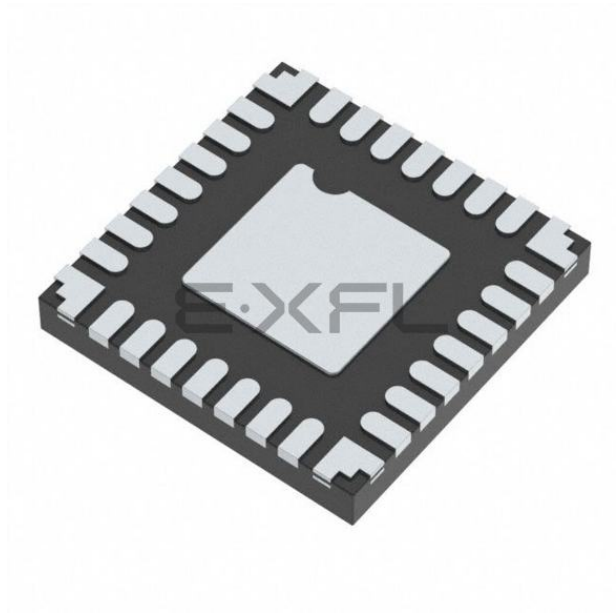
Microchip Technology - DSPIC33EP32GS202-I/M6 Datasheet



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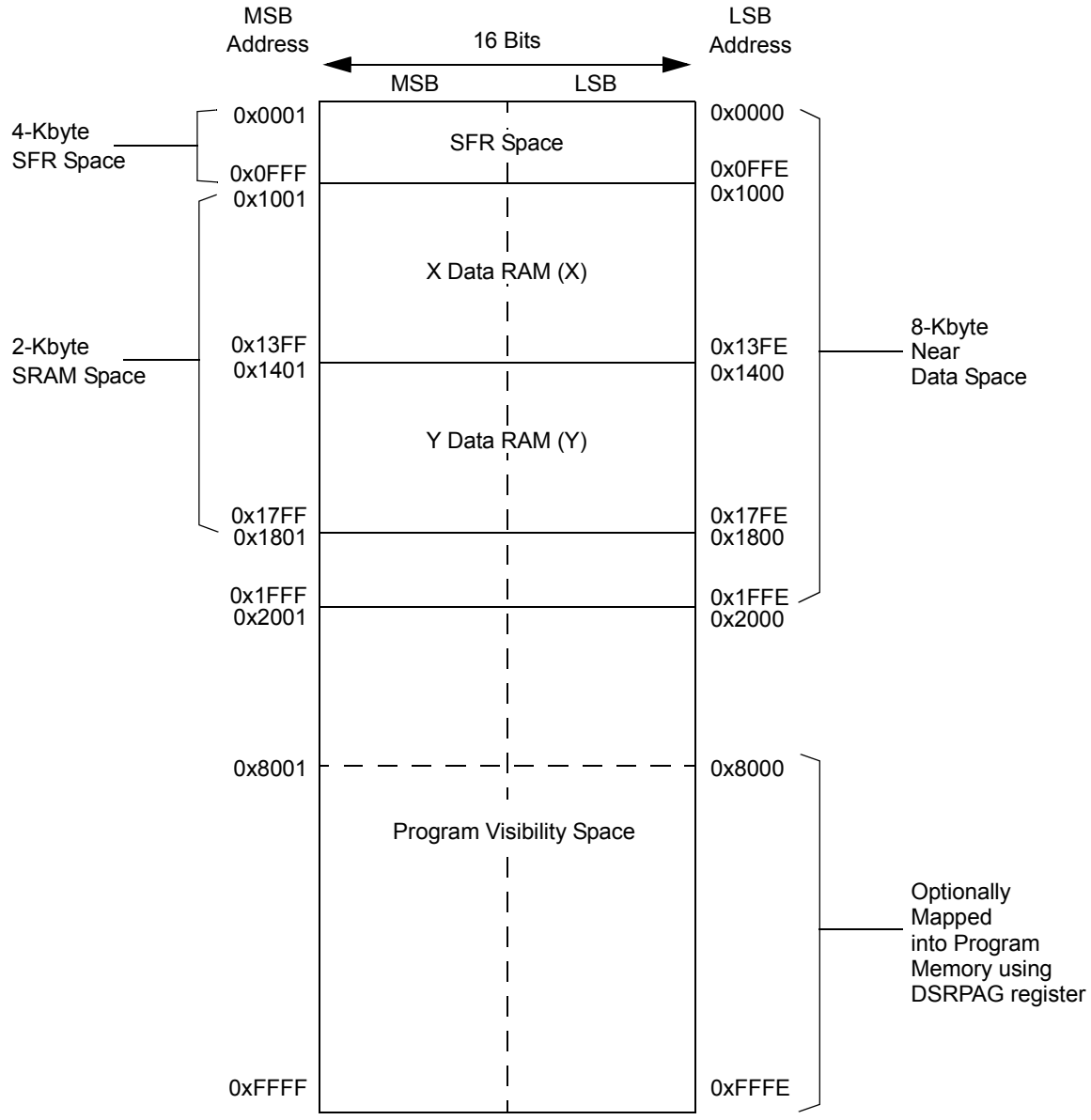
Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	dsPIC
Core Size	16-Bit
Speed	70 MIPs
Connectivity	I²C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	21
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 12x12b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-UFQFN Exposed Pad
Supplier Device Package	28-UQFN (4x4)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/dspic33ep32gs202-i-m6

FIGURE 4-4: DATA MEMORY MAP FOR dsPIC33EP16/32GS202 DEVICES



Note: Memory areas are not shown to scale.

4.3.5 X AND Y DATA SPACES

The dsPIC33EPXXGS202 core has two Data Spaces, X and Y. These Data Spaces can be considered either separate (for some DSP instructions) or as one unified linear address range (for MCU instructions). The Data Spaces are accessed using two Address Generation Units (AGUs) and separate data paths. This feature allows certain instructions to concurrently fetch two words from RAM, thereby enabling efficient execution of DSP algorithms, such as Finite Impulse Response (FIR) filtering and Fast Fourier Transform (FFT).

The X Data Space is used by all instructions and supports all addressing modes. X Data Space has separate read and write data buses. The X read data bus is the read data path for all instructions that view Data Space as combined X and Y address space. It is also the X data prefetch path for the dual operand DSP instructions (MAC class).

The Y Data Space is used in concert with the X Data Space by the MAC class of instructions (CLR, ED, EDAC, MAC, MOVSAC, MPY, MPY.N and MSC) to provide two concurrent data read paths.

Both the X and Y Data Spaces support Modulo Addressing mode for all instructions, subject to addressing mode restrictions. Bit-Reversed Addressing mode is only supported for writes to X Data Space.

All data memory writes, including in DSP instructions, view Data Space as combined X and Y address space. The boundary between the X and Y Data Spaces is device-dependent and is not user-programmable.

4.4 Memory Resources

Many useful resources are provided on the main product page of the Microchip web site for the devices listed in this data sheet. This product page contains the latest updates and additional information.

4.4.1 KEY RESOURCES

- **"dsPIC33E/PIC24E Program Memory"** (DS70000613) in the *"dsPIC33/PIC24 Family Reference Manual"*
- Code Samples
- Application Notes
- Software Libraries
- Webinars
- All Related *"dsPIC33/PIC24 Family Reference Manual"* Sections
- Development Tools

TABLE 4-3: INTERRUPT CONTROLLER REGISTER MAP

File Name	Addr.	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
IFS0	0800	NVMIF	—	ADCIF	U1TXIF	U1RXIF	SPI1IF	SPI1EIF	T3IF	T2IF	—	—	—	T1IF	OC1IF	IC1IF	INT0IF	0000
IFS1	0802	—	—	INT2IF	—	—	—	—	—	—	—	—	INT1IF	CNIF	AC1IF	MI2C1IF	SI2C1IF	0000
IFS3	0806	—	—	—	—	—	—	PSEMIF	—	—	—	—	—	—	—	—	—	0000
IFS4	0808	—	—	—	—	—	—	PSESIF	—	—	—	—	—	—	—	U1EIF	—	0000
IFS5	080A	PWM2IF	PWM1IF	—	—	—	—	—	—		—	—	—	—	—	—	—	0000
IFS6	080C	ADCAN1IF	ADCAN0IF	—	—	—	—	—	—	AC2IF	—	—	—	—	—	—	PWM3IF	0000
IFS7	080E	—	—	—	—	—	—	—	—	—	—	ADCAN7IF	ADCAN6IF	ADCAN5IF	ADCAN4IF	ADCAN3IF	ADCAN2IF	0000
IFS9	0812	—	—	ADCAN14IF	—	—	ADCAN11IF	ADCAN10IF	ADCAN9IF	ADCAN8IF	—	—	—	—	—	—	—	0000
IFS10	0814	—	—	I2C1BCIF	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
IFS11	0816	—	—	—	—	—	—	—	—	—	—	—	—	ADFL0IF	ADCMP1IF	ADCMP0IF	—	0000
IEC0	0820	NVMIE	—	ADCIE	U1TXIE	U1RXIE	SPI1IE	SPI1EIE	T3IE	T2IE	—	—	—	T1IE	OC1IE	IC1IE	INT0IE	0000
IEC1	0822	—	—	INT2IE	—	—	—	—	—	—	—	—	INT1IE	CNIE	AC1IF	MI2C1IE	SI2C1IE	0000
IEC3	0826	—	—	—	—	—	—	PSEMIE	—	—	—	—	—	—	—	—	—	0000
IEC4	0828	—	—	—	—	—	—	PSESIE	—	—	—	—	—	—	—	U1EIE	—	0000
IEC5	082A	PWM2IE	PWM1IE	—	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
IEC6	082C	ADCAN1IE	ADCAN0IE	—	—	—	—	—	AC3IE	AC2IE	—	—	—	—	—	—	PWM3IE	0000
IEC7	082E	—	—	—	—	—	—	—	—	—	—	ADCAN7IE	ADCAN6IE	ADCAN5IE	ADCAN4IE	ADCAN3IE	ADCAN2IE	0000
IEC9	0832	—	—	ADCAN14IE	—	—	ADCAN11IE	ADCAN10IE	ADCAN9IE	ADCAN8IE	—	—	—	—	—	—	—	0000
IEC10	0834	—	—	I2C1BCIE	—	—	—	—	—	—	—	—	—	—	—	—	—	0000
IEC11	0836	—	—	—	—	—	—	—	—	—	—	—	—	ADFL0IE	ADCMP1IE	ADCMP0IE	—	0000
IPC0	0840	—	T1IP2	T1IP1	T1IP0	—	OC1IP2	OC1IP1	OC1IP0	—	IC1IP2	IC1IP1	IC1IP0	—	INT0IP2	INT0IP1	INT0IP0	4444
IPC1	0842	—	T2IP2	T2IP1	T2IP0	—	—	—	—	—	—	—	—	—	—	—	—	4000
IPC2	0844	—	U1RXIP2	U1RXIP1	U1RXIP0	—	SPI1IP2	SPI1IP1	SPI1IP0	—	SPI1EIP2	SPI1EIP1	SPI1EIP0	—	T3IP2	T3IP1	T3IP0	4444
IPC3	0846	—	NVMIP2	NVMIP1	NVMIP0	—	—	—	—	—	ADCIP2	ADCIP1	ADCIP0	—	U1TXIP2	U1TXIP1	U1TXIP0	4044
IPC4	0848	—	CNIP2	CNIP1	CNIP0	—	AC1IP2	AC1IP1	AC1IP0	—	MI2C1IP2	MI2C1IP1	MI2C1IP0	—	SI2C1IP2	SI2C1IP1	SI2C1IP0	4444
IPC5	084A	—	—	—	—	—	—	—	—	—	—	—	—	—	INT1IP2	INT1IP1	INT1IP0	0004
IPC7	084E	—	—	—	—	—	—	—	—	—	INT2IP2	INT2IP1	INT2IP0	—	—	—	—	0040
IPC14	085C	—	—	—	—	—	—	—	—	—	PSEMIP2	PSEMIP1	PSEMIP0	—	—	—	—	0040

Legend: — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

TABLE 7-1: INTERRUPT VECTOR DETAILS (CONTINUED)

Interrupt Source	Vector #	IRQ #	IVT Address	Interrupt Bit Location		
				Flag	Enable	Priority
Reserved	126-158	118-150	0x000100-0x000140	—	—	—
AN8 Conversion Done	159	151	0x000142	IFS9<7>	IEC9<7>	IPC37<14:12>
AN9 Conversion Done	160	152	0x000144	IFS9<8>	IEC9<8>	IPC38<2:0>
AN10 Conversion Done	161	153	0x000146	IFS9<9>	IEC9<9>	IPC38<6:4>
AN11 Conversion Done	162	154	0x000148	IFS9<10>	IEC9<10>	IPC38<10:8>
Reserved	163-164	155-156	0x00014A-0x00014C	—	—	—
AN14 Conversion Done	165	157	0x00014E	IFS9<13>	IEC9<13>	IPC39<6:4>
Reserved	163-180	155-172	0x00014A-0x00016C	—	—	—
I2C1 – I2C1 Bus Collision	181	173	0x00016E	IFS10<13>	IEC10<13>	IPC43<6:4>
Reserved	182-184	174-176	0x000170-0x000174	—	—	—
ADCMP0 – ADC Digital Comparator 0	185	177	0x000176	IFS11<1>	IEC11<1>	IPC44<6:4>
ADCMP1 – ADC Digital Comparator 1	186	178	0x000178	IFS11<2>	IEC11<2>	IPC44<10:8>
ADFL0 – ADC Filter 0	187	179	0x00017A	IFS11<3>	IEC11<3>	IPC44<14:12>
Reserved	188-253	180-245	0x00017C-0x0001FE	—	—	—

REGISTER 7-3: INTCON1: INTERRUPT CONTROL REGISTER 1

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
NSTDIS	OVAERR	OVBERR	COVAERR	COVBERR	OVATE	OVBTE	COVTE
bit 15							bit 8

R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0
SFTACERR	DIV0ERR	—	MATHERR	ADDRERR	STKERR	OSCFAIL	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’	
-n = Value at POR	‘1’ = Bit is set	‘0’ = Bit is cleared	x = Bit is unknown

bit 15 **NSTDIS:** Interrupt Nesting Disable bit
1 = Interrupt nesting is disabled
0 = Interrupt nesting is enabled

bit 14 **OVAERR:** Accumulator A Overflow Trap Flag bit
1 = Trap was caused by overflow of Accumulator A
0 = Trap was not caused by overflow of Accumulator A

bit 13 **OVBERR:** Accumulator B Overflow Trap Flag bit
1 = Trap was caused by overflow of Accumulator B
0 = Trap was not caused by overflow of Accumulator B

bit 12 **COVAERR:** Accumulator A Catastrophic Overflow Trap Flag bit
1 = Trap was caused by catastrophic overflow of Accumulator A
0 = Trap was not caused by catastrophic overflow of Accumulator A

bit 11 **COVBERR:** Accumulator B Catastrophic Overflow Trap Flag bit
1 = Trap was caused by catastrophic overflow of Accumulator B
0 = Trap was not caused by catastrophic overflow of Accumulator B

bit 10 **OVATE:** Accumulator A Overflow Trap Enable bit
1 = Trap overflow of Accumulator A
0 = Trap is disabled

bit 9 **OVBTE:** Accumulator B Overflow Trap Enable bit
1 = Trap overflow of Accumulator B
0 = Trap is disabled

bit 8 **COVTE:** Catastrophic Overflow Trap Enable bit
1 = Trap on catastrophic overflow of Accumulator A or B is enabled
0 = Trap is disabled

bit 7 **SFTACERR:** Shift Accumulator Error Status bit
1 = Math error trap was caused by an invalid accumulator shift
0 = Math error trap was not caused by an invalid accumulator shift

bit 6 **DIV0ERR:** Divide-by-Zero Error Status bit
1 = Math error trap was caused by a divide-by-zero
0 = Math error trap was not caused by a divide-by-zero

bit 5 **Unimplemented:** Read as ‘0’

bit 4 **MATHERR:** Math Error Status bit
1 = Math error trap has occurred
0 = Math error trap has not occurred

REGISTER 10-26: RPOR10: PERIPHERAL PIN SELECT OUTPUT REGISTER 10

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP181R5	RP181R4	RP181R3	RP181R2	RP181R1	RP181R0
bit 15							bit 8

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	RP180R5	RP180R4	RP180R3	RP180R2	RP180R1	RP180R0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

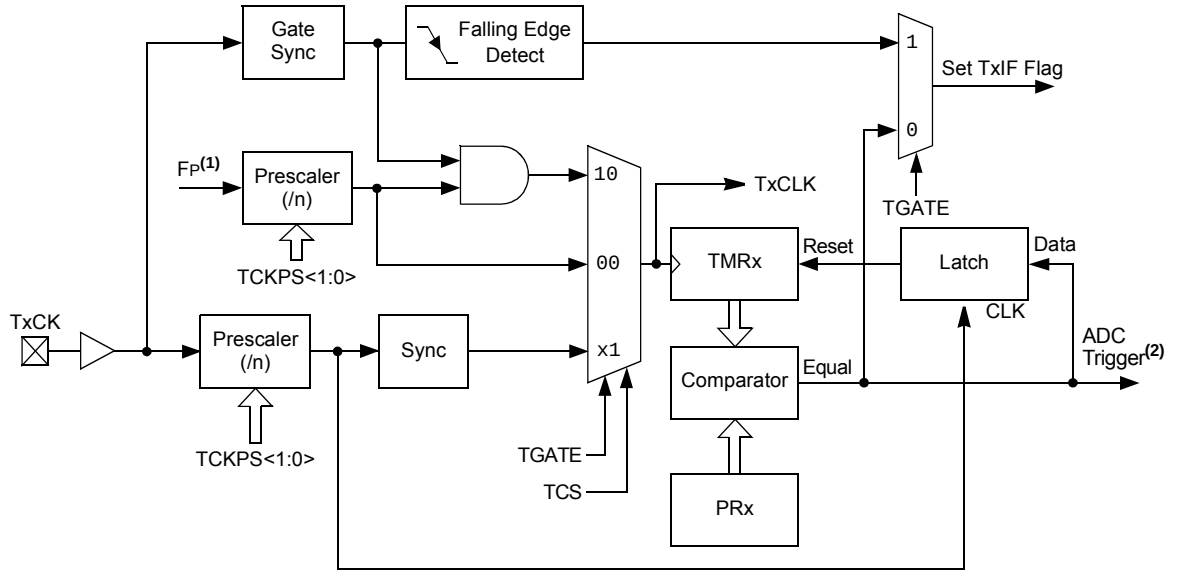
bit 15-14 **Unimplemented:** Read as '0'

bit 13-8 **RP181R<5:0>:** Peripheral Output Function is Assigned to RP181 Output Pin bits (see Table 10-2 for peripheral function numbers)

bit 7-6 **Unimplemented:** Read as '0'

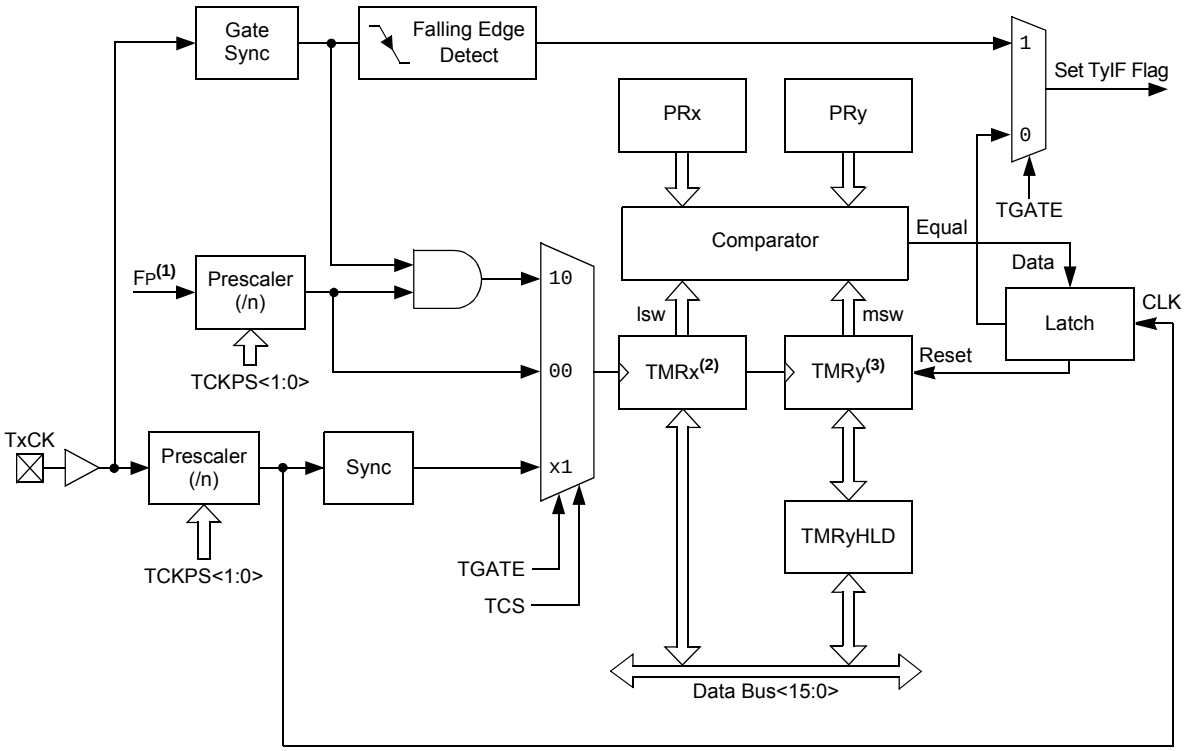
bit 5-0 **RP180R<5:0>:** Peripheral Output Function is Assigned to RP180 Output Pin bits (see Table 10-2 for peripheral function numbers)

FIGURE 12-1: TIMERx BLOCK DIAGRAM (x = 2,3)



Note 1: FP is the Peripheral Clock.
2: The ADC trigger is only available on TMR2.

FIGURE 12-2: TYPE B/TYPE C TIMER PAIR BLOCK DIAGRAM (32-BIT TIMER)



Note 1: FP is the Peripheral Clock.
2: Timerx is a Type B timer (x = 2).
3: Timery is a Type C timer (y = 3).

13.2 Input Capture Registers

REGISTER 13-1: IC1CON1: INPUT CAPTURE CONTROL REGISTER 1

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	U-0	U-0
—	—	ICSIDL	ICTSEL2	ICTSEL1	ICTSEL0	—	—
bit 15							bit 8

U-0	R/W-0	R/W-0	R-0, HC, HS	R-0, HC, HS	R/W-0	R/W-0	R/W-0
—	ICI1	ICI0	ICOV	ICBNE	ICM2	ICM1	ICM0
bit 7							bit 0

Legend:	HC = Hardware Clearable bit	HS = Hardware Settable bit	
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-14 **Unimplemented:** Read as '0'

bit 13 **ICSIDL:** Input Capture Stop in Idle Control bit
- 1 = Input capture will halt in CPU Idle mode
- 0 = Input capture will continue to operate in CPU Idle mode

bit 12-10 **ICTSEL<2:0>:** Input Capture Timer Select bits
- 111 = Peripheral Clock (FP) is the clock source of the IC1
- 110 = Reserved
- 101 = Reserved
- 100 = T1CLK is the clock source of the IC1 (only the synchronous clock is supported)
- 011 = Reserved
- 010 = Reserved
- 001 = T2CLK is the clock source of the IC1
- 000 = T3CLK is the clock source of the IC1

bit 9-7 **Unimplemented:** Read as '0'

bit 6-5 **ICI<1:0>:** Number of Captures per Interrupt Select bits (this field is not used if ICM<2:0> = 001 or 111)
- 11 = Interrupt on every fourth capture event
- 10 = Interrupt on every third capture event
- 01 = Interrupt on every second capture event
- 00 = Interrupt on every capture event

bit 4 **ICOV:** Input Capture Overflow Status Flag bit (read-only)
- 1 = Input capture buffer overflow has occurred
- 0 = No input capture buffer overflow has occurred

bit 3 **ICBNE:** Input Capture Buffer Not Empty Status bit (read-only)
- 1 = Input capture buffer is not empty, at least one more capture value can be read
- 0 = Input capture buffer is empty

bit 2-0 **ICM<2:0>:** Input Capture Mode Select bits
- 111 = Input capture functions as an interrupt pin only in CPU Sleep and Idle modes (rising edge detect only, all other control bits are not applicable)
- 110 = Unused (module is disabled)
- 101 = Capture mode, every 16th rising edge (Prescaler Capture mode)
- 100 = Capture mode, every 4th rising edge (Prescaler Capture mode)
- 011 = Capture mode, every rising edge (Simple Capture mode)
- 010 = Capture mode, every falling edge (Simple Capture mode)
- 001 = Capture mode, every rising and falling edge (Edge Detect mode, (ICI<1:0>) is not used in this mode)
- 000 = Input capture is turned off

15.0 HIGH-SPEED PWM

Note: This data sheet summarizes the features of the dsPIC33EPXXGS202 family of devices. It is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **"High-Speed PWM Module"** (DS70000323) in the *"dsPIC33/PIC24 Family Reference Manual"*, which is available from the Microchip web site (www.microchip.com).

The high-speed PWM module on dsPIC33EPXXGS202 devices supports a wide variety of PWM modes and output formats. This PWM module is ideal for power conversion applications, such as:

- AC/DC Converters
- DC/DC Converters
- Power Factor Correction
- Uninterruptible Power Supply (UPS)
- Inverters
- Battery Chargers
- Digital Lighting

15.1 Features Overview

The high-speed PWM module incorporates the following features:

- Three PWM Generators with Two Outputs per Generator
- Two Master Time Base Modules
- Individual Time Base and Duty Cycle for each PWM Output
- Duty Cycle, Dead Time, Phase Shift and a Frequency Resolution of 1.04 ns
- Independent Fault and Current-Limit Inputs
- Redundant Output
- True Independent Output
- Center-Aligned PWM mode
- Output Override Control
- Chop mode (also known as Gated mode)
- Special Event Trigger
- Dual Trigger from PWM to Analog-to-Digital Converter (ADC)
- PWMxL and PWMxH Output Pin Swapping
- Independent PWMx Frequency, Duty Cycle and Phase-Shift Changes
- Enhanced Leading-Edge Blanking (LEB) Functionality
- PWMx Capture Functionality

Note: Duty cycle, dead time, phase shift and frequency resolution is 8.32 ns in Center-Aligned PWM mode.

Figure 15-1 conceptualizes the PWM module in a simplified block diagram. Figure 15-2 illustrates how the module hardware is partitioned for each PWM output pair for the Complementary PWM mode.

The PWM module contains three PWM generators. The module has up to six PWM output pins: PWM1H/PWM1L through PWM3H/PWM3L. For complementary outputs, these six I/O pins are grouped into high/low pairs.

15.2 Feature Description

The PWM module is designed for applications that require:

- High resolution at high PWM frequencies
- The ability to drive Standard, Edge-Aligned, Center-Aligned Complementary and Push-Pull mode outputs
- The ability to create multiphase PWM outputs

Two common, medium power converter topologies are push-pull and half-bridge. These designs require the PWM output signal to be switched between alternate pins, as provided by the Push-Pull PWM mode.

Phase-shifted PWM describes the situation where each PWM generator provides outputs, but the phase relationship between the generator outputs is specifiable and changeable.

Multiphase PWM is often used to improve DC/DC Converter load transient response, and reduce the size of output filter capacitors and inductors. Multiple DC/DC Converters are often operated in parallel, but phase shifted in time. A single PWM output operating at 250 kHz has a period of 4 μs, but an array of four PWM channels, staggered by 1 μs each, yields an effective switching frequency of 1 MHz. Multiphase PWM applications typically use a fixed-phase relationship.

Variable phase PWM is useful in Zero Voltage Transition (ZVT) power converters. Here, the PWM duty cycle is always 50% and the power flow is controlled by varying the relative phase shift between the two PWM generators.

REGISTER 15-12: PWMCONx: PWMx CONTROL REGISTER (CONTINUED)

bit 7-6 **DTC<1:0>:** Dead-Time Control bits
11 = Reserved
10 = Dead-time function is disabled
01 = Negative dead time is actively applied for Complementary Output mode
00 = Positive dead time is actively applied for all Output modes

bit 5-4 **Unimplemented:** Read as '0'

bit 3 **MTBS:** Master Time Base Select bit
1 = PWMx generator uses the secondary master time base for synchronization and the clock source for the PWMx generation logic (if secondary time base is available)
0 = PWMx generator uses the primary master time base for synchronization and the clock source for the PWMx generation logic

bit 2 **CAM:** Center-Aligned Mode Enable bit(2,3,4)
1 = Center-Aligned mode is enabled
0 = Edge-Aligned mode is enabled

bit 1 **XPRES:** External PWMx Reset Control bit(5)
1 = Current-limit source resets the time base for this PWMx generator if it is in Independent Time Base mode
0 = External pins do not affect the PWMx time base

bit 0 **IUE:** Immediate Update Enable bit
1 = Updates to the active Duty Cycle, Phase Offset, Dead-Time and local Time Base Period registers are immediate
0 = Updates to the active Duty Cycle, Phase Offset, Dead-Time and local Time Base Period registers are synchronized to the local PWMx time base

Note 1: Software must clear the interrupt status here and in the corresponding IFSx register in the interrupt controller.
2: The Independent Time Base mode (ITB = 1) must be enabled to use Center-Aligned mode. If ITB = 0, the CAM bit is ignored.
3: These bits should not be changed after the PWM is enabled by setting PTEN (PTCON<15>) = 1.
4: Center-Aligned mode ignores the Least Significant 3 bits of the Duty Cycle, Phase and Dead-Time registers. The highest Center-Aligned mode resolution available is 8.32 ns with the clock prescaler set to the fastest clock.
5: Configure CLMOD (FCLCONx<8>) = 0 and ITB (PWMCONx<9>) = 1 to operate in External Period Reset mode.

REGISTER 17-2: I2C1CONH: I2C1 CONTROL REGISTER HIGH

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 15							bit 8

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	PCIE	SCIE	BOEN	SDAHT	SBCDE	AHEN	DHEN
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-7 **Unimplemented:** Read as '0'

bit 6 **PCIE:** Stop Condition Interrupt Enable bit (I^2C Slave mode only)
1 = Enables interrupt on detection of Stop condition
0 = Stop detection interrupts are disabled

bit 5 **SCIE:** Start Condition Interrupt Enable bit (I^2C Slave mode only)
1 = Enables interrupt on detection of Start or Restart conditions
0 = Start detection interrupts are disabled

bit 4 **BOEN:** Buffer Overwrite Enable bit (I^2C Slave mode only)
1 = I2C1RCV is updated and an ACK is generated for a received address/data byte, ignoring the state of the I2COV bit only if the RBF bit = 0
0 = I2C1RCV is only updated when I2COV is clear

bit 3 **SDAHT:** SDA1 Hold Time Selection bit
1 = Minimum of 300 ns hold time on SDA1 after the falling edge of SCL1
0 = Minimum of 100 ns hold time on SDA1 after the falling edge of SCL1

bit 2 **SBCDE:** Slave Mode Bus Collision Detect Enable bit (I^2C Slave mode only)
1 = Enables slave bus collision interrupts
0 = Slave bus collision interrupts are disabled
If the rising edge of SCL1 and SDA1 is sampled low when the module is in a high state, the BCL bit is set and the bus goes Idle. This Detection mode is only valid during data and ACK transmit sequences.

bit 1 **AHEN:** Address Hold Enable bit (I^2C Slave mode only)
1 = Following the 8th falling edge of SCL1 for a matching received address byte, the SCLREL (I2C1CONL<12>) bit will be cleared and SCL1 will be held low
0 = Address holding is disabled

bit 0 **DHEN:** Data Hold Enable bit (I^2C Slave mode only)
1 = Following the 8th falling edge of SCL1 for a received data byte, the slave hardware clears the SCLREL (I2C1CONL<12>) bit and SCL1 is held low
0 = Data holding is disabled

REGISTER 19-16: ADMOD0L: ADC INPUT MODE CONTROL REGISTER 0 LOW

U-0	R/W-0	U-0	R/W-0	U-0	R/W-0	U-0	R/W-0
—	SIGN7	—	SIGN6	—	SIGN5	—	SIGN4
bit 15							bit 8

U-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	SIGN3	—	SIGN2	DIFF1	SIGN1	DIFF0	SIGN0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit (odd)15-5 **Unimplemented:** Read as '0'

bit (3,1) **DIFF<x>:** Pseudo-Differential Mode for Corresponding Analog Inputs bits
1 = Channel is pseudo-differential
0 = Channel is single-ended

bit (even) **SIGNx:** Output Data Sign for Corresponding Analog Inputs bits
1 = Channel output data is signed
0 = Channel output data is unsigned

REGISTER 19-17: ADMOD0H: ADC INPUT MODE CONTROL REGISTER 0 HIGH

U-0	U-0	U-0	R/W-0	U-0	R/W-0	U-0	R/W-0
—	—	—	SIGN14	—	SIGN13	—	SIGN12
bit 15							bit 8

U-0	R/W-0	U-0	R/W-0	U-0	R/W-0	U-0	R/W-0
—	SIGN11	—	SIGN10	—	SIGN9	—	SIGN8
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-13 **Unimplemented:** Read as '0'

bit (odd) **Unimplemented:** Read as '0'

bit (even) **SIGN<x>:** Output Data Sign for Corresponding Analog Inputs bits
1 = Channel output data is signed
0 = Channel output data is unsigned

REGISTER 19-23: ADCAL1H: ADC CALIBRATION REGISTER 1 HIGH

R/W-0, HS	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
CSHRRDY	—	—	—	CSHRSKIP	CSHRDIFF	CSHREN	CSHRRUN
bit 15							bit 8

U-0	U-0	U-0	U-0	U-0	U-0	U-0	U-0
—	—	—	—	—	—	—	—
bit 7							bit 0

Legend:	HS = Hardware Settable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15 **CSHRRDY:** Shared ADC Core Calibration Status Flag bit
1 = Shared ADC core calibration is finished
0 = Shared ADC core calibration is in progress

bit 14-12 **Unimplemented:** Read as '0'

bit 11 **CSHRSKIP:** Shared ADC Core Calibration Bypass bit
1 = After power-up, the shared ADC core will not be calibrated
0 = After power-up, the shared ADC core will be calibrated

bit 10 **CSHRDIFF:** Shared ADC Core Pseudo-Differential Input Mode Calibration bit
1 = Shared ADC core will be calibrated in Pseudo-Differential Input mode
0 = Shared ADC core will be calibrated in Single-Ended Input mode

bit 9 **CSHREN:** Shared ADC Core Calibration Enable bit
1 = Shared ADC core calibration bits (CSHRRDY, CSHRSKIP, CSHRDIFF and CSHRRUN) can be accessed by software
0 = Shared ADC core calibration bits are disabled

bit 8 **CSHRRUN:** Shared ADC Core Calibration Start bit
1 = If this bit is set by software, the shared ADC core calibration cycle is started; this bit is cleared automatically by hardware
0 = Software can start the next calibration cycle

bit 7-0 **Unimplemented:** Read as '0'

TABLE 23-2: INSTRUCTION SET OVERVIEW

Base Instr #	Assembly Mnemonic	Assembly Syntax		Description	# of Words	# of Cycles	Status Flags Affected
1	ADD	ADD	Acc	Add Accumulators	1	1	OA,OB,SA,SB
		ADD	f	f = f + WREG	1	1	C,DC,N,OV,Z
		ADD	f,WREG	WREG = f + WREG	1	1	C,DC,N,OV,Z
		ADD	#lit10,Wn	Wd = lit10 + Wd	1	1	C,DC,N,OV,Z
		ADD	Wb,Ws,Wd	Wd = Wb + Ws	1	1	C,DC,N,OV,Z
		ADD	Wb,#lit5,Wd	Wd = Wb + lit5	1	1	C,DC,N,OV,Z
		ADD	Wso,#Slit4,Acc	16-bit Signed Add to Accumulator	1	1	OA,OB,SA,SB
2	ADDC	ADDC	f	f = f + WREG + (C)	1	1	C,DC,N,OV,Z
		ADDC	f,WREG	WREG = f + WREG + (C)	1	1	C,DC,N,OV,Z
		ADDC	#lit10,Wn	Wd = lit10 + Wd + (C)	1	1	C,DC,N,OV,Z
		ADDC	Wb,Ws,Wd	Wd = Wb + Ws + (C)	1	1	C,DC,N,OV,Z
		ADDC	Wb,#lit5,Wd	Wd = Wb + lit5 + (C)	1	1	C,DC,N,OV,Z
3	AND	AND	f	f = f .AND. WREG	1	1	N,Z
		AND	f,WREG	WREG = f .AND. WREG	1	1	N,Z
		AND	#lit10,Wn	Wd = lit10 .AND. Wd	1	1	N,Z
		AND	Wb,Ws,Wd	Wd = Wb .AND. Ws	1	1	N,Z
		AND	Wb,#lit5,Wd	Wd = Wb .AND. lit5	1	1	N,Z
4	ASR	ASR	f	f = Arithmetic Right Shift f	1	1	C,N,OV,Z
		ASR	f,WREG	WREG = Arithmetic Right Shift f	1	1	C,N,OV,Z
		ASR	Ws,Wd	Wd = Arithmetic Right Shift Ws	1	1	C,N,OV,Z
		ASR	Wb,Wns,Wnd	Wnd = Arithmetic Right Shift Wb by Wns	1	1	N,Z
		ASR	Wb,#lit5,Wnd	Wnd = Arithmetic Right Shift Wb by lit5	1	1	N,Z
5	BCLR	BCLR	f,#bit4	Bit Clear f	1	1	None
		BCLR	Ws,#bit4	Bit Clear Ws	1	1	None
7	BRA	BRA	C,Expr	Branch if Carry	1	1 (4)	None
		BRA	GE,Expr	Branch if greater than or equal	1	1 (4)	None
		BRA	GEU,Expr	Branch if unsigned greater than or equal	1	1 (4)	None
		BRA	GT,Expr	Branch if greater than	1	1 (4)	None
		BRA	GTU,Expr	Branch if unsigned greater than	1	1 (4)	None
		BRA	LE,Expr	Branch if less than or equal	1	1 (4)	None
		BRA	LEU,Expr	Branch if unsigned less than or equal	1	1 (4)	None
		BRA	LT,Expr	Branch if less than	1	1 (4)	None
		BRA	LTU,Expr	Branch if unsigned less than	1	1 (4)	None
		BRA	N,Expr	Branch if Negative	1	1 (4)	None
		BRA	NC,Expr	Branch if Not Carry	1	1 (4)	None
		BRA	NN,Expr	Branch if Not Negative	1	1 (4)	None
		BRA	NOV,Expr	Branch if Not Overflow	1	1 (4)	None
		BRA	NZ,Expr	Branch if Not Zero	1	1 (4)	None
		BRA	OA,Expr	Branch if Accumulator A overflow	1	1 (4)	None
		BRA	OB,Expr	Branch if Accumulator B overflow	1	1 (4)	None
		BRA	OV,Expr	Branch if Overflow	1	1 (4)	None
		BRA	SA,Expr	Branch if Accumulator A saturated	1	1 (4)	None
		BRA	SB,Expr	Branch if Accumulator B saturated	1	1 (4)	None
		BRA	Expr	Branch Unconditionally	1	4	None
		BRA	Z,Expr	Branch if Zero	1	1 (4)	None
		BRA	Wn	Computed Branch	1	4	None
8	BSET	BSET	f,#bit4	Bit Set f	1	1	None
		BSET	Ws,#bit4	Bit Set Ws	1	1	None

Note: Read and Read-Modify-Write (e.g., bit operations and logical operations) on non-CPU SFRs incur an additional instruction cycle.

TABLE 25-8: DC CHARACTERISTICS: POWER-DOWN CURRENT (I_{PD})

DC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended		
Parameter No.	**Typ.**	**Max.**	**Units**	**Conditions**	
Power-Down Current (I_{PD})(1)					
DC60d	10	30	μA	-40°C	3.3V
DC60a	16	60	μA	+25°C	
DC60b	60	300	μA	+85°C	
DC60c	300	800	μA	+125°C	

Note 1: I_{PD} (Sleep) current is measured as follows:

- CPU core is off, oscillator is configured in EC mode and external clock is active; OSC1 is driven with external square wave from rail-to-rail (EC Clock Overshoot/Undershoot < 250 mV required)
- CLKO is configured as an I/O input pin in the Configuration Word
- All I/O pins are configured as output and driving low.
- $\overline{MCLR}$ = V_{DD}, WDT and FSCM are disabled
- All peripheral modules are disabled (PMDx bits are all set)
- The VREGS bit (RCON<8>) = 0 (i.e., core regulator is set to standby while the device is in Sleep mode)
- The VREGSF bit (RCON<11>) = 0 (i.e., Flash regulator is set to standby while the device is in Sleep mode)
- JTAG is disabled

TABLE 25-9: DC CHARACTERISTICS: WATCHDOG TIMER DELTA CURRENT (ΔI_{WDT})(1)

DC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended		
Parameter No.	**Typ.**	**Max.**	**Units**	**Conditions**	
DC61d	1	2	μA	-40°C	3.3V
DC61a	1	2	μA	+25°C	
DC61b	1	3	μA	+85°C	
DC61c	2	5	μA	+125°C	

Note 1: The ΔI_{WDT} current is the additional current consumed when the module is enabled. This current should be added to the base I_{PD} current. All parameters are characterized but not tested during manufacturing.

FIGURE 25-2: EXTERNAL CLOCK TIMING

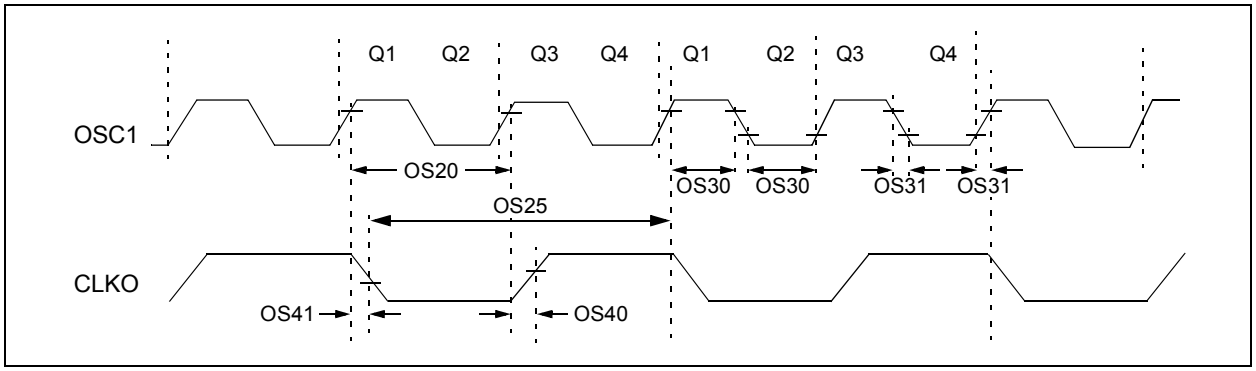


TABLE 25-17: EXTERNAL CLOCK TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	**Symb**	**Characteristic**	**Min.**	**Typ.(1)**	**Max.**	**Units**	**Conditions**
OS10	FIN	External CLKI Frequency (External clocks allowed only in EC and ECPLL modes)	DC	—	60	MHz	EC
		Oscillator Crystal Frequency	3.5 10	— —	10 40	MHz MHz	XT HS
OS20	TOSC	TOSC = 1/FOSC	8.33	—	DC	ns	+125°C
		TOSC = 1/FOSC	7.14	—	DC	ns	+85°C
OS25	TCY	Instruction Cycle Time(2)	16.67	—	DC	ns	+125°C
		Instruction Cycle Time(2)	14.28	—	DC	ns	+85°C
OS30	TosL, TosH	External Clock in (OSC1) High or Low Time	0.45 x TOSC	—	0.55 x TOSC	ns	EC
OS31	TosR, TosF	External Clock in (OSC1) Rise or Fall Time	—	—	20	ns	EC
OS40	TckR	CLKO Rise Time(3,4)	—	5.2	—	ns	
OS41	TckF	CLKO Fall Time(3,4)	—	5.2	—	ns	
OS42	GM	External Oscillator Transconductance(4)	—	12	—	mA/V	HS, VDD = 3.3V, TA = +25°C
			—	6	—	mA/V	XT, VDD = 3.3V, TA = +25°C

Note 1: Data in "Typ." column is at 3.3V, +25°C unless otherwise stated.

2: Instruction cycle period (TCY) equals two times the input oscillator time base period. All specified values are based on characterization data for that particular oscillator type, under standard operating conditions, with the device executing code. Exceeding these specified limits may result in an unstable oscillator operation and/or higher than expected current consumption. All devices are tested to operate at "Minimum" values with an external clock applied to the OSC1 pin. When an external clock input is used, the "Maximum" cycle time limit is "DC" (no clock) for all devices.

3: Measurements are taken in EC mode. The CLKO signal is measured on the OSC2 pin.

4: Parameters are for design guidance only and are not tested in manufacturing.

TABLE 25-20: INTERNAL FRC ACCURACY

AC CHARACTERISTICS		Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended					
Param No.	**Characteristic**	**Min.**	**Typ.**	**Max.**	**Units**	**Conditions**	
Internal FRC Accuracy @ FRC Frequency = 7.37 MHz(1,2)							
F20a	FRC	-2	0.5	+2	%	-40°C ≤ TA ≤ -10°C	VDD = 3.0-3.6V
		-0.9	0.5	+0.9	%	-10°C ≤ TA ≤ +85°C	VDD = 3.0-3.6V
F20b	FRC	-2	1	+2	%	+85°C ≤ TA ≤ +125°C	VDD = 3.0-3.6V

Note 1: Frequency is calibrated at +25°C and 3.3V. TUNx bits can be used to compensate for temperature drift.

2: Over the lifetime of the 28-Lead 4x4 UQFN package device, the internal FRC accuracy could vary between ±4%.

TABLE 25-21: INTERNAL LPRC ACCURACY

AC CHARACTERISTICS		Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended					
Param No.	**Characteristic**	**Min.**	**Typ.**	**Max.**	**Units**	**Conditions**	
LPRC @ 32.768 kHz(1)							
F21a	LPRC	-30	—	+30	%	-40°C ≤ TA ≤ -10°C	VDD = 3.0-3.6V
		-20	—	+20	%	-10°C ≤ TA ≤ +85°C	VDD = 3.0-3.6V
F21b	LPRC	-30	—	+30	%	+85°C ≤ TA ≤ +125°C	VDD = 3.0-3.6V

Note 1: This is the change of the LPRC frequency as VDD changes.

TABLE 25-36: SPI1 SLAVE MODE (FULL-DUPLEX, CKE = 1, CKP = 1, SMP = 0) TIMING REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended				
Param No.	**Symbol**	**Characteristic(1)**	**Min.**	**Typ.(2)**	**Max.**	**Units**	**Conditions**
SP70	FscP	Maximum SCK1 Input Frequency	—	—	Lesser of: FP or 11	MHz	**(Note 3)**
SP72	TscF	SCK1 Input Fall Time	—	—	—	ns	See Parameter DO32 **(Note 4)**
SP73	TscR	SCK1 Input Rise Time	—	—	—	ns	See Parameter DO31 **(Note 4)**
SP30	TdoF	SDO1 Data Output Fall Time	—	—	—	ns	See Parameter DO32 **(Note 4)**
SP31	TdoR	SDO1 Data Output Rise Time	—	—	—	ns	See Parameter DO31 **(Note 4)**
SP35	TscH2doV, TscL2doV	SDO1 Data Output Valid After SCK1 Edge	—	6	20	ns	
SP36	TdoV2scH, TdoV2scL	SDO1 Data Output Setup to First SCK1 Edge	30	—	—	ns	
SP40	TdiV2scH, TdiV2scL	Setup Time of SDI1 Data Input to SCK1 Edge	30	—	—	ns	
SP41	TscH2diL, TscL2diL	Hold Time of SDI1 Data Input to SCK1 Edge	30	—	—	ns	
SP50	TssL2scH, TssL2scL	$\overline{SS1}$ ↓ to SCK1 ↑ or SCK1 ↓ Input	120	—	—	ns	
SP51	TssH2doZ	$\overline{SS1}$ ↑ to SDO1 Output High-Impedance	10	—	50	ns	**(Note 4)**
SP52	TscH2ssH, TscL2ssH	$\overline{SS1}$ ↑ after SCK1 Edge	1.5 TCY + 40	—	—	ns	**(Note 4)**
SP60	TssL2doV	SDO1 Data Output Valid after $\overline{SS1}$ Edge	—	—	50	ns	

Note 1: These parameters are characterized but not tested in manufacturing.

2: Data in "Typ." column is at 3.3V, +25°C unless otherwise stated.

3: The minimum clock period for SCK1 is 91 ns. Therefore, the SCK1 clock generated by the master must not violate this specification.

4: Assumes 50 pF load on all SPI1 pins.

TABLE 25-39: I2C1 BUS DATA TIMING REQUIREMENTS (MASTER MODE)

AC CHARACTERISTICS				Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial -40°C ≤ TA ≤ +125°C for Extended			
Param No.	**Symbol**	**Characteristic(4)**		**Min.(1)**	**Max.**	**Units**	**Conditions**
IM10	TLO:SCL	Clock Low Time	100 kHz mode	TCY (BRG + 1)	—	µs	
			400 kHz mode	TCY (BRG + 1)	—	µs	
			1 MHz mode(2)	TCY (BRG + 1)	—	µs	
IM11	THI:SCL	Clock High Time	100 kHz mode	TCY (BRG + 1)	—	µs	
			400 kHz mode	TCY (BRG + 1)	—	µs	
			1 MHz mode(2)	TCY (BRG + 1)	—	µs	
IM20	TF:SCL	SDA1 and SCL1 Fall Time	100 kHz mode	—	300	ns	CB is specified to be from 10 to 400 pF
			400 kHz mode	20 + 0.1 CB	300	ns	
			1 MHz mode(2)	—	100	ns	
IM21	TR:SCL	SDA1 and SCL1 Rise Time	100 kHz mode	—	1000	ns	CB is specified to be from 10 to 400 pF
			400 kHz mode	20 + 0.1 CB	300	ns	
			1 MHz mode(2)	—	300	ns	
IM25	TSU:DAT	Data Input Setup Time	100 kHz mode	250	—	ns	
			400 kHz mode	100	—	ns	
			1 MHz mode(2)	40	—	ns	
IM26	THD:DAT	Data Input Hold Time	100 kHz mode	0	—	µs	
			400 kHz mode	0	0.9	µs	
			1 MHz mode(2)	0.2	—	µs	
IM30	TSU:STA	Start Condition Setup Time	100 kHz mode	TCY (BRG + 1)	—	µs	Only relevant for Repeated Start condition
			400 kHz mode	TCY (BRG + 1)	—	µs	
			1 MHz mode(2)	TCY (BRG + 1)	—	µs	
IM31	THD:STA	Start Condition Hold Time	100 kHz mode	TCY (BRG + 1)	—	µs	After this period, the first clock pulse is generated
			400 kHz mode	TCY (BRG + 1)	—	µs	
			1 MHz mode(2)	TCY (BRG + 1)	—	µs	
IM33	TSU:STO	Stop Condition Setup Time	100 kHz mode	TCY (BRG + 1)	—	µs	
			400 kHz mode	TCY (BRG + 1)	—	µs	
			1 MHz mode(2)	TCY (BRG + 1)	—	µs	
IM34	THD:STO	Stop Condition Hold Time	100 kHz mode	TCY (BRG + 1)	—	µs	
			400 kHz mode	TCY (BRG + 1)	—	µs	
			1 MHz mode(2)	TCY (BRG + 1)	—	µs	
IM40	TAA:SCL	Output Valid from Clock	100 kHz mode	—	3500	ns	
			400 kHz mode	—	1000	ns	
			1 MHz mode(2)	—	400	ns	
IM45	TBF:SDA	Bus Free Time	100 kHz mode	4.7	—	µs	Time the bus must be free before a new transmission can start
			400 kHz mode	1.3	—	µs	
			1 MHz mode(2)	0.5	—	µs	
IM50	CB	Bus Capacitive Loading		—	400	pF	
IM51	TPGD	Pulse Gobbler Delay		65	390	ns	**(Note 3)**

Note 1: BRG is the value of the I^2C Baud Rate Generator.

2: Maximum Pin Capacitance = 10 pF for all I2C1 pins (for 1 MHz mode only).

3: Typical value for this parameter is 130 ns.

4: These parameters are characterized but not tested in manufacturing.

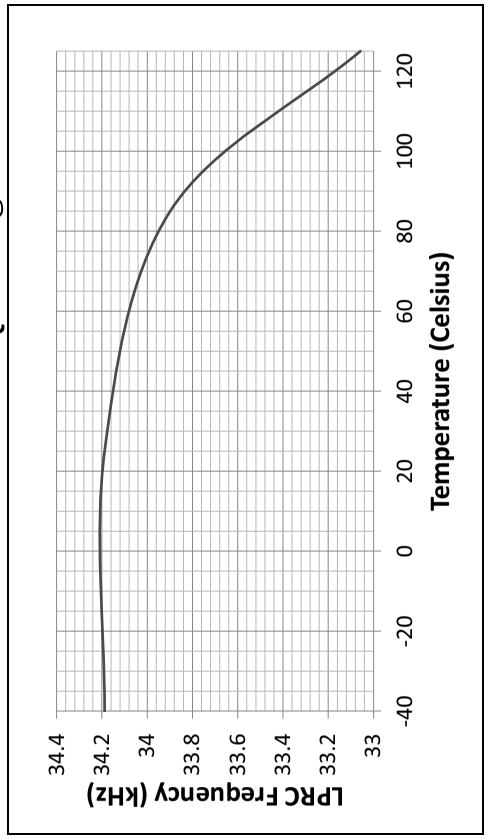


FIGURE 26-10: TYPICAL LPRC FREQUENCY @ V_{DD} = 3.3V

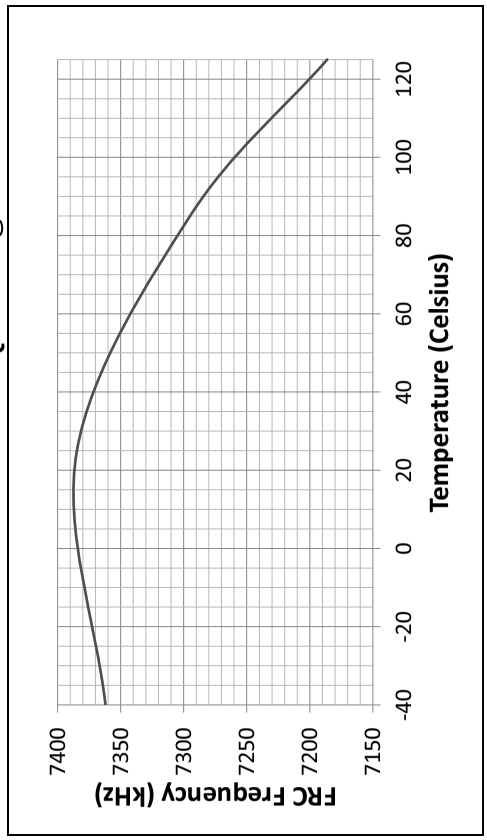


FIGURE 26-9: TYPICAL FRC FREQUENCY @ V_{DD} = 3.3V